



Product Specification

SPECIFICATION FOR APPROVAL

()	Prelii	nınary	Speci	fication
(•)	Final	Specif	icatio	1

Title 5.0" FHD TFT-LCD

BUYER	Open
MODEL	

^{*} LGD cannot guarantee any defect and mura which is occurred after laminating Touch.

SUPPLIER	LG Display Co., Ltd.
*MODEL	LH500WF2
SUFFIX	SH01

*When you obtain standard approval, please use the above model name without suffix

	DATE	SIGNATURE
		1
th	our confirmation with	Please return 1 copy for yo
t	/our confirmation wit	Please return 1 copy for your signature and comme

APPROVED BY	DATE
S.D. Jung / Team Leader	13/18/
REVIEWED BY	Mi m
Y.S. Kim / Part Leader	Cly 1/4
PREPARED BY	
J.S. Yoon / Research Engineer	MM 1/4

Ver 1.0 July. 02. 2013





Product Specification

Contents

/er 1.0	July. 02. 2013	1 /30
C.	AUTION & HANDLING PRECAUTIONS	29 Page
	12.1 Environmental Reliability Tests	28 Page
12. R	eliability	28 Page
	11.2 PALLET ASS'Y	27 Page
	11.1 PACKING ASS'Y	27 Page
	acking Form	27 Page
	10.1 LCD Layout	25 Page
	utline Dimension	25 Page
	9.1 Recommended Software Flow	16 Page
	ial Sequence	16 Page
{	3.2 Power on/off sequence	14 Page
8	8.1 Reset Timing	13 Page
8. Pc	ower on/off sequence	13 Page
	7.2 Recommended FPC Schematic	12 Page
7	7.1 Pin Configuration to design FPC	10 Page
7. FI	PC Description	10 Page
6. O	ptical Specifications	6 Page
;	5.1 DC Characteristics	5 Page
5. El	lectrical Characteristics	5 Page
4. Al	bsolute Maximum Rating	4 Page
3. G	eneral Features	3 Page
2. G	eneral Description	3 Page
1. R	ecord of Revisions	2 Page





Product Specification

1. Record of Revisions

Revision No.	Date	Contents of Revision Change	Remark
0.0	13.06.12	Preliminary Specification Release	All page
1.0	13.07.02	Final Specification Release	All page





Product Specification

2. General Description

The LH500WF2 is a color transmissive display with wide viewing angle function. This matrix employs LTPS (Low Temperature Poly-Silicon) thin film transistors as the active elements. The gate drivers are integrated on this panel. This model has 4.97 inch diagonal size with FHD pixel format(1,080 x RGB x 1,920). This model operates in the normally black mode.

Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the luminance of the sub-pixel color is determined with a 8-bit gray scale signal for each dot, thus, presenting a palette of more than 16,777,216 colors.

3. General Features

No	Item	Specification	Remark
1	Display Method	Active Matrix TFT	
2	Display Mode	Transmissive Type	
3	Outline Dimensions [mm]	63.884(H) X 116.596(V) X 0.3(D)	w/o Polarizer
4	Active Area [mm]	61.884(H) × 110.016(V)	
5	Display Resolution	1080(H) X RGB X 1920(V)	
6	Pixel Pitch [mm]	0.0191 × RGB(H) × 0.0573(V)	443 PPI
7	Pixel Arrangement	RGB Vertical stripes	
8-1	Panel Transmittance	2.73%	VSP 5V, VSN -5V
8-2	(/w Polarizer)	2.9%	VSP 5.2V, VSN -5.2V
9	Color Gamut	70%(typ.), only C/F	CIE standard C light source is used
10	Inversion Type	Column inversion	
11	Interface	MIPI 4-lanes	
12	Driver IC	R63315	29.8mm(H) × 0.85mm(V) × 0.17mm(D)
13	Weight [g]	5.53g±10%	w/o Polarizer

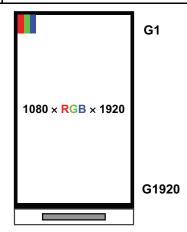


Fig 3.1. Block Diagram of LH500WF2-SH01

Ver 1.0 July. 02. 2013 3 /30





Product Specification

4. Absolute Maximum Rating

The following are maximum values which, if exceeded, may cause operation or damage to the unit.

ltem	Symbol	Min.	Max.	Unit	Remark
LC Operating Voltage	V	4.5 (T	yp.)	V	Note 1), 1-1)
LC Operating Voltage	V_{OP}	4.7 (T	yp.)	V	Note 1), 1-2)
Storage Humidity	H _{STG}	10	90	%RH	Note 2), 3)
Storage Temperature	T _{STG}	-30	80	°C	Note 2), 3)
Operating Ambient Humidity	H _{OP}	10	90	%RH	Note 2), 3)
Operating Ambient Temperature	T _{OP}	-20	70	°C	Note 2), 3)

Note 1) Liquid Crystal (LC) driving voltage.

Due to the characteristics of LC materials, this voltage vary with environmental temperature.

Note 1-1) VSP 5V, VSN -5V

Note 1-2) VSP 5.2V, VSN -5.2V

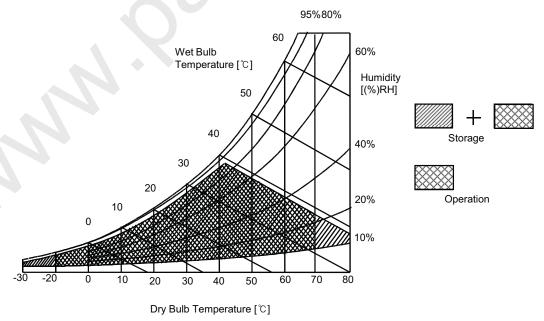
Note 2) Temp. $\leq 60^{\circ}$ C , 90% RH MAX.

Temp. $> 60 \,^{\circ}\mathrm{C}$, Absolute humidity shall be less than 90% RH at $60 \,^{\circ}\mathrm{C}$.

Note 3) The diagram below indicates the peripheral environment of the module.

The wet bulb temperature should be kept under 39 $^{\circ}\text{C}$ and there should be no compensation.

If the LSI is used above these absolute maximum ratings, it may become permanently damaged.



Ver 1.0 July. 02. 2013 4 /30





Product Specification

6. Optical Specifications

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25°C. The values specified are at an approximate distance 50cm from the LCD surface.

Measurement condition

Optical Test Equipment & method refer to Note 6-1. (LED back light with 20mA/1ea)

- 1): with polarizer
 - cf. Polarizer attachment tolerance + optical axis = $\pm 0.1^{\circ}$

The tolerance of the angle between rubbing axis of cell and absorption axis of polarizer is $\pm 0.1^{\circ}$

2): Only Color Filter glass. (CIE standard C light source is used)

Item	Symbol	Condition	Unit	Min.	Тур.	Max	Notes		
	Тор			70	80	-			
Viewing Angle (1)	Bottom	CR>10°	Degree -	70	80	-	Note 1),4)		
Viewing Angle (1)	Right	CR>10		70	80	-			
	Left			70	80	-			
Contrast Ratio (1)	C/R		1-1	800	1000	-	Note 1),3)		
Panel Transmittance (1)	BP		%	2.3	2.73	-	VSP 5V, VSN -5V		
	DF		/0	2.45	2.9	-	VSP 5.2V, VSN -5.2V		
Crosstalk			%	-	-	6	Note 1),2)		
Response Time (1)	Tr+Tf		ms	-	30	35	Note 1),5)		
	Rx			0.620	0.640	0.660			
	Ry			0.310	0.330	0.350			
	Gx	0.00	0.0°	0 0°		0.280	0.300	0.320	
Color Chromaticity (2)	Gy	Θ = 0°	NTSC	0.580	0.600	0.620			
Color Chromaticity (2)	Bx		(x.y)	0.140	0.150	0.170			
	Ву			0.040	0.060	0.080			
	Wx			0.290	0.310	0.330			
	Wy			0.300	0.320	0.340			

^{*} Optical Test Equipment & Method Refer to Note 1, 2, 3, 4, 5,

Ver 1.0 July. 02. 2013 5 /30

Guarantee Crosstalk
 just in case of operation with '9.1. Recommended Software Flow' on page 16.





Product Specification

5. Electrical Characteristics

5.1 DC Characteristics

 $T_a = 25^{\circ}C$

Item	Symbol	Min.	Тур.	Max.	Unit	Note
TFT Gate ON Voltage	VGH	8.4	9.4	10.4	V	Note 1)
TFT Gate OFF Voltage	VGL	-10.4	-9.4	-8.4	V	Note 2)
TFT Common Electrode Voltage	VCOM	-0.5	-0.3	-0.1	V	Note 3)

Note 1) VGH is TFT Gate operating voltage.

Note 2) VGL is TFT Gate off voltage.

Note 3) VCOM must be adjusted to optimize display quality: Cross-talk, Contrast Ratio and etc.

In order to get the optimized display quality, the setting-voltage should be changed as based on customer's developing condition.

(The display quality could be changed by customer's setting-voltage.)

We just kindly recommend the setting-voltage as the reference value.

In order to get the optimized display quality, the setting-voltage should be changed as based on customer's developing condition.

(The display quality could be changed by customer's setting-voltage.)





Product Specification

Note 1) Optical Test Equipment Setup

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 5 minutes in a dark environment at 25°C. The values specified are at an approximate distance 50cm from the LCD surface. In case of backlight on, measured on the center area of the panel by PHOTO RESEARCH photometer PR-880&PR650 or Equivalent.

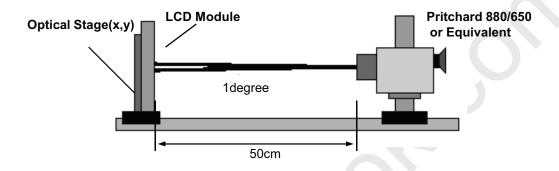


Fig. 6.1.1 Optical Characteristic Measurement Equipment and Method

Measuring Condition:

- Measuring surroundings: Dark Room
- Measuring temperature
 T_a=25°C
- Adjust operating voltage to get optimum contrast at the center of the display.
- Measured value at the center P1 point of LCD panel after more than 5 minutes while backlight turning on.

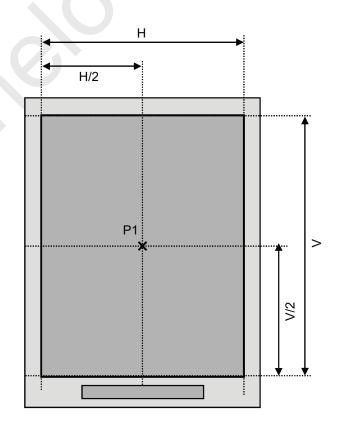


Fig 6.1.2. LCD measurement point





Product Specification

Note 2) Crosstalk

- A: Luminance for P1 ~ P4 with all 127gray pixels
- B: Luminance for P1 ~ P4
 with 127gray pixels
 when the white box is applied

Crosstalk [%] =

Maximum $\left[Absolute \left(\frac{A - B}{A} \right) \right]$

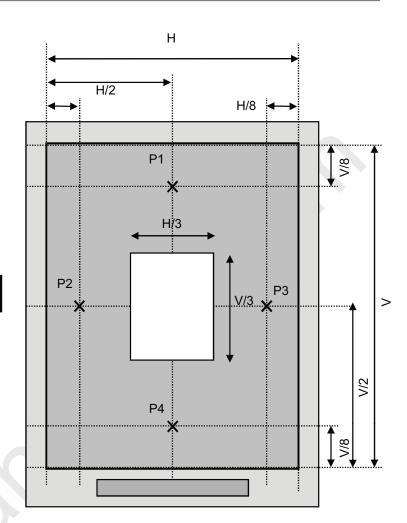


Fig. 6.3. Crosstalk measurement points

Note 3)

Contrast Ratio is defined as follows ;

Contrast Ratio (CR) = Photo detector output with LCD being "White"

Photo detector output with LCD being "Black"

Ver 1.0 July. 02. 2013 8 /30





Product Specification

Note 4)

Viewing Angle Range is defined as follows;

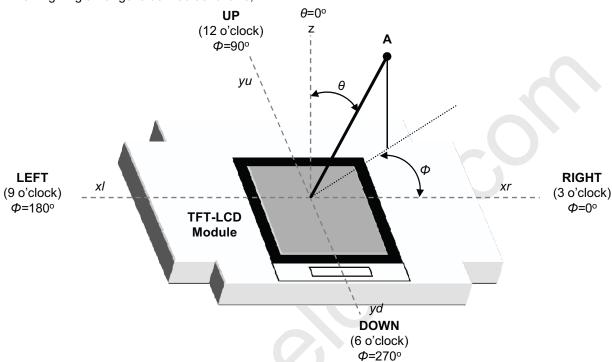
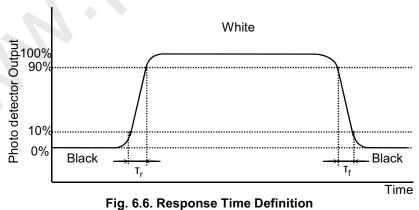


Fig. 6.5. Viewing Angle Definitions

Note 5)

Response time is obtained by measuring the transition time of photo detector output, when input signals are applied so as to make the area "black" to and from "white".



Ver 1.0 July. 02. 2013 9 /30





Product Specification

7. FPC Description

7.1 Pin Configuration to design FPC

No.	Symbol	Description	No.	Symbol	Description
1~5	Dummy		57,58	VDD	For the internal logic operation
6	GND		59	IOVCCRF	IOVCC
7	Dummy		60~62	IOVCC	
8	AG_PASTE		63	GNDRF	GND
9,10	VCOM		64,65	GND	
11	AGND		66	LEDPWM	
12	GVSS		67	EXCK	4 4 4 4 4 5 7 4 5 7 9
13	GND		68	DBIST	Connected GND at FPC
14	PBCTLA1		69	LNSW1	
15	PBCTLA2		70	LNSW0	
16	PBCTLB1	Open	71	PNSW	Connected IOVCC at FPC
17	PBCTLB2		72	IM2	
18,19	GVDD		73	IM1	
20,21	VGH		74	IM0	Connected GND at FPC
22~24	C21P	Capacitor connection	75	VSOUT	VSYNC OUT
25~27	C21M	Pins for step-up circuit	76	HSOUT	- Open
28~30	SVDD		77	TE2	Ореп
31~33	VSP		78	TE	
34	EXPWRP	VSP	79	CSX	
35	VSWP	Open	80	DCX	Connected IOVCC at FPC
36,37	svss		81	WRX/SCL	
38,39	VSN		82	DOUT	Open
40,41	AGND		83	DIN	Connected IOVCC at FPC
42,43	C41M	0	84	RESX	
44,45	C41P	Open	85,86	IOVCC	
46,47	VCL		87~90	GND	
48~50	VCI		91~94	AGND	
51	Dummy		95~98	VCI	
52,53	VCOM		99~103	SVDD	
54	VCOMDC	Capacitor connection Pins for internal VCOM	104,105	VGS	
55,56	AGND		106~110	SVSS	

Ver 1.0 July. 02. 2013 10 /30

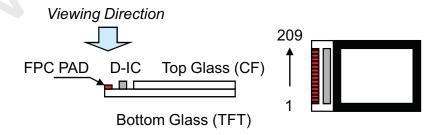




Product Specification

Table 7-1. FPC Pin Configuration (Continued.)

No.	Symbol	Description	No.	Symbol	Description
111~114	VCL		160~162	GND	
115~118	AGND		163~165	AGND	
119~122	GND		166	DUMMYR1	Open
123,124	VDD		167	DUMMYR2	Open
125	IOVCC		168,169	VCL	
126,127	GND		170~172	VCI	
128~130	DPHYGND	GND	173,174	SVDD	
131,132	DATA2P	MIPI Data2+	175,176	VSP	
133,134	DATA2N	MIPI Data2-	177	EXPWRN	VSP
135	DPHYGNDDUM1	GND	178~180	VSN	
136,137	DATA1P	MIPI Data1+	181~183	svss	
138,139	DATA1N	MIPI Data1-	184	VSWN	Open
140	DPHYGNDDUM2	GND	185~187	C31P	Capacitor connection
141,142	CLKP	MIPI CLK +	188~190	C31M	Pins for step-up circuit
143,144	CLKN	MIPI CLK -	191,192	VGL	
145	DPHYGNDDUM3	GND	193,194	GVSS	
146,147	DATA0P	MIPI Data0+	195,196	GND	
148,149	DATA0N	MIPI Data0-	197	GVDD	
150	DPHYGNDDUM4	GND	198,199	AGND	
151,152	DATA3P	MIPI Data3+	200,201	VCOM	
153,154	DATA3N	MIPI Data3-	202~207	Dummy	
155~157	DPHYVCC	Connected IOVCC at FPC	208	GND	
158,159	VDDLP	Capacitor connection Pins for internal LDO	209	Dummy	



11/30 Ver 1.0 July. 02. 2013

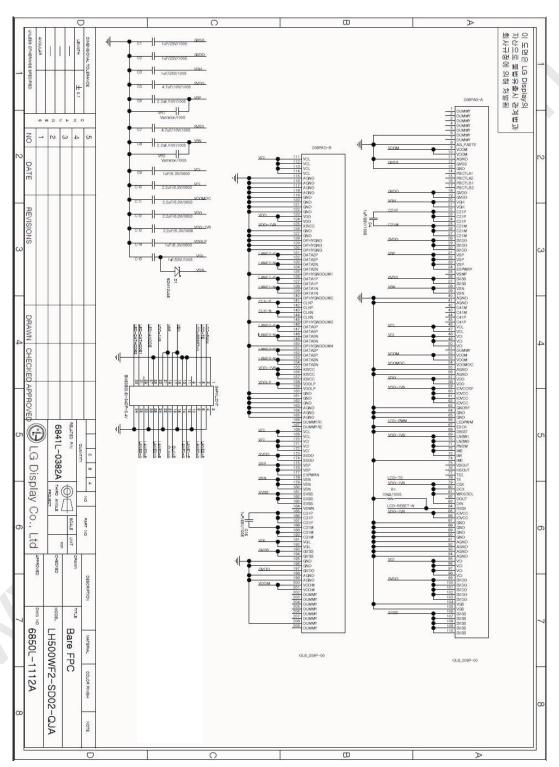




Product Specification

7.2. Recommended FPC Schematic

The following schematic is one of the recommendation for the optimized performance of this LCD.





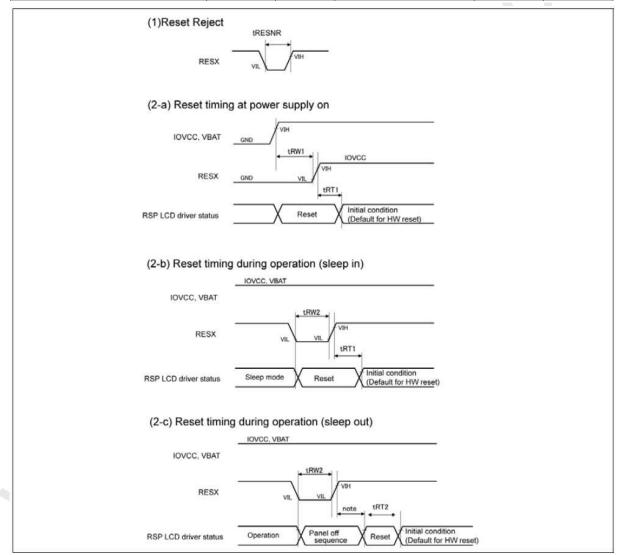


Product Specification

8. Power on/off Sequence

8.1 Reset Timing

Item	Symbol	Unit	Test condition	Min.	Max.
Reset low-level width1	tRW1	us	Power supply on	1000	_
Reset low-level width2	tRW2	us	Operation	1000	_
Reset time (Sleep IN)	tRT1	ms	_	_	3
Reset time (Sleep OUT)	tRT2	ms	_	_	3
Noise reject width	tRESNR	us	_	_	1

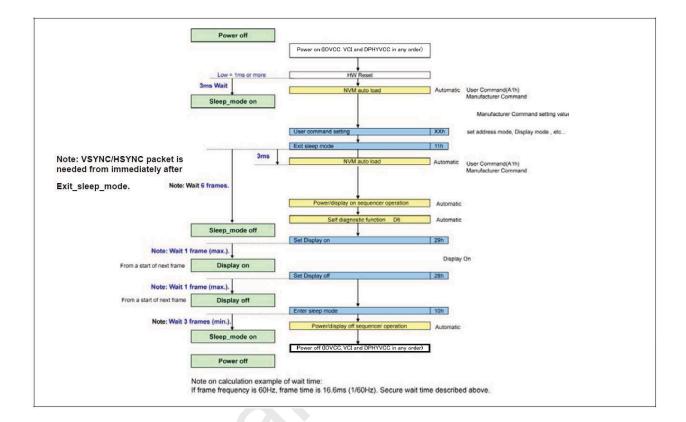






Product Specification

8.2 Power On/Off Sequence



Ver 1.0 July. 02. 2013 14 /30

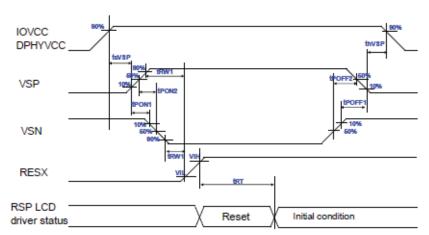




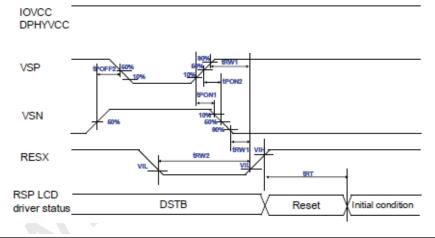
Product Specification

8.2 Power On/Off Sequence (continued)

a)Power On Sequence



b)Deep standby mode Sequence



Item	Symbol	Unit	Test Condition	Min	Max
VSP-VSN delay time (10% to 10%)	tPON1	us	Power On	0	_
VSP-VSN delay time (50% to 50%)	tPON2	us	Power On	0	_
System power on to VSP ON time	tsVSP	ms	Power On	1	_
Reset low-level width1	tRW1	ms	Power On	1	_
Reset low-level width2	tRW2	ms	Power Off	1	-
Reset time (Sleep IN)	tRT	ms	Power On	3	_
VSN-VSP delay time (10% to 10%)	tPOFF1	us	Power Off	0	_
VSN-VSP delay time (50% to 50%)	tPOFF2	us	Power Off	0	_
VSP OFF to system power off time	thVSP	us	Power Off	0	_

Ver 1.0 July. 02. 2013 15 /30



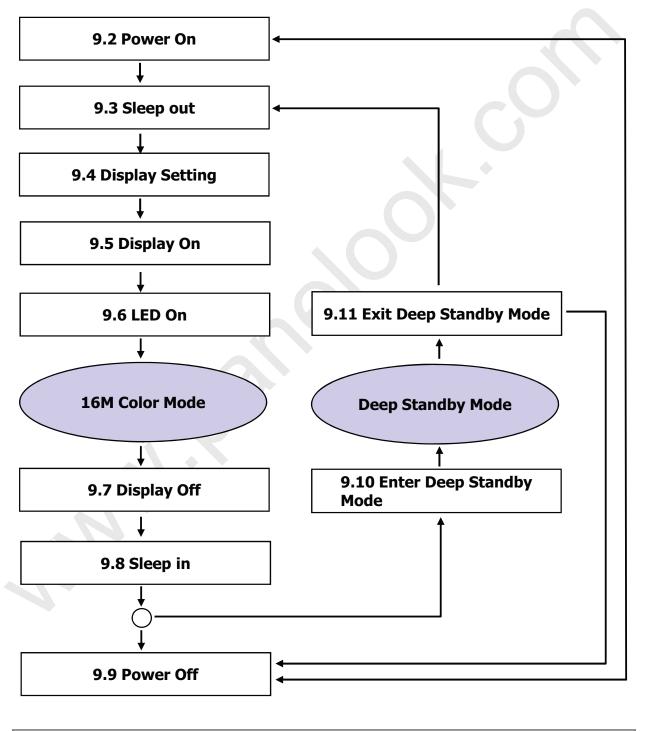


Product Specification

9. Initial Sequence

9.1. Recommended Software Flow

The following flow is one of the recommendation for the optimized performance of this LCD.







Product Specification

Table 9.2. Power On Set

Step	REGISTER FUNCTION	INDEX/DATA	HEX		
1	Power on (IOVCC)				
2	Wait > 1ms				
3	Power on (VSP, VSN in any order)				
4	Wait > 1ms				
5	RESX high				
6	Wait > 3ms				

Table 9.3. Sleep Out

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
1	0x05	Sleep Out	INDEX	0x11
2 Wait > 100.2ms (6-frame)				





Product Specification

Table 9.4. Display Initial Set

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX	
1	0x23	Manufacturer Command	INDEX	0xB0	
	UXZS	Access Protect	DATA	0x04	
			INDEX	0xB3	
2	0x29	Interface Setting	DATA	0x14 0x00 0x00 0x00 0x00	
			DATA	0x00	
3	0x29	DCI Control (MIDI Speed)	INDEX	0xB6	
3	UXZ9	DSI Control (MIPI Speed)	DATA	0x3A 0xD3	
4	0x29	Slew Rate Setting	INDEX	0xC0	
4	UXZ9		DATA	0x00	
			INDEX	0xC1	
				0x84 0x60 0x10 0xEB 0xFF	
		Display Setting1			0x6F 0xCE 0xFF 0xFF 0x17
5	0x29		DATA	0x12 0x58 0x73 0xAE 0x31	
5	UXZ9			0x20 0xC6 0xFF 0xFF 0x1F	
				0xF3 0xFF 0x5F 0x10 0x10	
				0x10 0x10 0x00 0x62 0x01	
				0x22 0x22 0x00 0x01	
			INDEX	0xC2	
7	0x29	x29 Display Setting2	DATA	0x31 0xF7 0x80 0x06 0x08	
			DATA	0x80 0x00	

Ver 1.0 July. 02. 2013 18 /30





Product Specification

Table 9.4. continued

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
			INDEX	0xC4
				0x70 0x00 0x00 0x00 0x00
9	0x29	Course Timing Cotting		0x00 0x00 0x00 0x00 0x0C
9	UXZ9	Source Timing Setting	DATA	0x06 0x00 0x00 0x00 0x00
				0x00 0x00 0x00 0x00 0x00
				0x0C 0x06
			INDEX	0xC6
				0x00 0x02 0x6c 0x02 0x6c
				0x00 0x00 0x00 0x00 0x00
				0x00 0x00 0x00 0x00 0x00
10	0x29	LTPS Timing Setting	DATA	0x00 0x00 0x0C 0x19 0X0A
				0x01 0x02 0x6c 0x02 0x6c
				0x00 0x00 0x00 0x00 0x00
				0x00 0x00 0x00 0x00 0x00
				0x00 0x00 0x0C 0x19 0x0a
		0.0	INDEX	0xC7
			DATA	0x00 0x05 0x0A 0x12 0x20
				0x30 0x3D 0x51 0x39 0x43
11	0x29	Gamma Setting		0x50 0x60 0x66 0x6D 0x78
			DATA	0x00 0x05 0x0A 0x12 0x20
				0x30 0x3D 0x51 0x39 0x43
				0x50 0x60 0x66 0x6D 0x78
			INDEX	0xC8
				0x01 0x00 0x00 0x00 0x00
12	0x29	Digital Gamma Setting	DATA	0xFC 0x00 0x00 0x00 0x00
			DATA	0x00 0xFC 0x00 0x00 0x00
				0x00 0x00 0xFC 0x00

Ver 1.0 July. 02. 2013 19 /30





Product Specification

Table 9.4. continued

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
			INDEX	0xCB
14	0x29	Panel PIN Control	DATA	0x31 0xFC 0x3F 0x8C 0x00
			DATA	0x00 0x00 0x00 0xC0
15	0x23	23 Panel Interface Control	INDEX	0xCC
15	0,25	Panel Interface Control	DATA	0x0B
			INDEX	0xD0
16	0x29	Power Setting For Charge Pump	DATA	0x11 0x81 0xBB 0x1B 0x1B
		3 1 1	DATA	0x4C 0x19 0x19 0x0C 0x00
			INDEX	0xD3
			0x1B 0x33 0xBB 0xBB 0xB3	
			DATA	0x33 0x33 0x33 0x01 0x01
		(V	(VSP 5V,	0x00 0xA0 0xD8 0xA0 0x0d
			VSN -5V)	0x56 0x56 0x33 0x3B 0x22
17	0x29	Power Setting for Internal Power		0x72 0x07 0x3D 0xBF 0x33
				0x1B 0x33 0xBB 0xBB 0xB3
			DATA	0x33 0x33 0x33 0x01 0x01
		(VSP 5.2V,	0x00 0xA0 0xD8 0xA0 0x0d	
		VSN -5.2V)	0x5F 0x5F 0x33 0x3B 0x22	
			0x72 0x07 0x3D 0xBF 0x55	
			INDEX	0xD5
18	0x29	VCOM Setting	DATA	0x06 0x00 0x00 0x01 0x32
			DATA	0x01 0x32

Ver 1.0 July. 02. 2013 20 /30





Product Specification

Table 9.5. Display On

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
1	0x05	Display On	INDEX	0x29
2 Wa			/ait > 16.7ms (1-1	frame)

Table 9.6. LED On

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
1	0x15 Write Display Brightness (Amount of light: 100%)	INDEX	0x51	
1		DATA	0xFF	
2) Out V	Write Control Display (LEDPWM)	INDEX	0x53
2	0X13		DATA	0x2C
3	Write Content		INDEX	0x55
3 0x15	(15 Adaptive Brightness Control (SRE off, CABC Off)	DATA	0x00	

Table 9.7. Display Off

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
1	0x05	Display Off	INDEX	0x28
2 W			/ait > 16.7ms (1-	frame)

Table 9.8. Sleep In

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX			
1	0x05	Sleep In	INDEX	0x10			
	2	Wait > 50.1ms (3-frame)					





Product Specification

Table 9.9. Power Off

Step	REGISTER FUNCTION	INDEX/DATA	HEX				
1	Power Off (VSP, VSN In Any Order)						
2	Wait > 0ms						
3	Power Off (IOVCC)						

Table 9.10. Enter Deep Standby Mode

Step	Data Type	REGISTER FUNCTION	INDEX/DATA	HEX
1 0x23		Manufacture Command	INDEX	0xB0
1	0,23	Access	DATA	0x04
2	0x29	DSTB	INDEX	0xB1
2 0x2	0,29	פוכט	DATA	0x01

Table 9.11. Exit Deep Standby Mode

Step	REGISTER FUNCTION	INDEX/DATA	HEX					
1		RESX low						
2		Wait > 1ms						
3		RESX high						
4		Wait > 3ms						





Product Specification

Table 9.1.7. DCS Data Type List

			Host to RSP LCD driver Data Type (RX)									
	W/R				W	rite Type	Read Type			Other		
DCS Command/Parameter		Data Type	05'h	15'h	39'h	13'h	23'h	29'h	14'h	24'h	06'h	37'h
		Packet	Short	Short	Long	Short	Short	Long	Short	Short	Short	Short
		DCS para	DCS no para	DCS 1 para	DCS	Generic 1 para	Generic 2 para	Generic -	Generic 1 para	Generic 2 para	DCS no para	Set max. return packet size
00h	nop	С	Yes	No	Yes	No	No	No	No	No	No	888
01h	soft_reset	С	Yes	No	Yes	No	No	No	No	No	No) <u>1</u>
04h	read_DDB_start	16	No	No	No	No	No	No	No	No	Yes	16'h10
05h	read_Number_of_the_ Errors_on_DSI	1	No	No	No	No	No	No	No	No	Yes	16"h1
06h	get_red_channel	1	No	No	No	No	No	No	No	No	Yes	
07h	get_green_channel	1	No	No	No	No	No	No	No	No	Yes	
08h	get_blue_channel	1	No	No	No	No	No	No	No	No	Yes	
0Ah	get_power_mode	~ i	No	No	No	No	No	No	No	No	Yes	16'h1
0Bh	get_address_mode	1	No	No	No	No	No	No	No	No	Yes	16'h1
0Ch	get_pixel_format	1	No	No	No	No	No	No	No	No	Yes	16'h1
0Dh	get_display_mode	1	No	No	No	No	No	No	No	No	Yes	16'h1
0Eh	get_signal_mode	1	No	No	No	No	No	No	No	No	Yes	16'h1
0Fh	get_diagnostic_result	1	No	No	No	No	No	No	No	No	Yes	16'h1
10h	enter_sleep_mode	С	Yes	No	Yes	No	No	No	No	No	No	-
11h	exit_sleep_mode	С	Yes	No	Yes	No	No	No	No	No	No	-
26h	set_gamma_curve	1	No	Yes	Yes	No	No	No	No	No	No	-
28h	set_display_off	С	Yes	No	Yes	No	No	No	No	No	No	-
29h	set_display_on	С	Yes	No	Yes	No	No	No	No	No	No	-





Product Specification

Table 9.1.8. MCS Data Type List

		Host to RSP LCD driver Data Type (RX)									
	W/R			W	rite Type			ı	Other		
MCS	Data Type	05'h	15'h	39'h	13'h	23'h	29'11	14'h	24'lı	06'h	37'h
Command/Parameter	Packet	Short	Short	Long	Short	Short	Long	Short	Short	Short	Short
	MCS para	DCS no para	DCS 1 para	DCS	Generic 1 para	Generic 2 para	Generic -	Generic 1 para	Generic 2 para	DCS no para	Set max. return packet size
MCS Read only command	1	No	No	No	No	No	No	Yes	No	No	16'h1
MCS write/read command	1	No	No	No	No	Yes	Yes	Yes	No	No	16'h1
MCS write/read command	1 < n	No	No	No	No	No	Yes	Yes	No	No	16'hn

Note) When each data type packet is sent, it is necessary to write all parameters of each DCS and MCS.





Product Specification

10. Outline Dimension

10.1. LCD Layout

The contents provide general outline dimension characteristics for the model LH500WF2-SH01. Symbols and reference of the outline dimension are summarized in Fig 9.1.

Table 10.1. Mechanical Characteristics of the LH500WF2-SH01

Parameter	Symbol	Specification	Unit	Notes
Active Area	А	61.884	mm	
Active Area	В	110.016	mm	
Llaman Class Circ	С	63.884	mm	
Upper Glass Size	D	113.136	mm	
Dattava Olasa Oira	E	63.884	mm	
Bottom Glass Size	F	116.596	mm	
Panel Thickness	Т	0.3	mm	
	G	1.0	mm	
	Н	2.12	mm	
Cell Margin	1	1.0	mm	
	J	1.0	mm	
COG PAD Area	К	3.46	mm	
Upper Glass Edge to D-IC	L	0.6	mm	
Bottom Glass Edge to D-IC	М	1.2	mm	
D-IC to FPC	N	0.4	mm	
FPC to Glass Edge	0	0.8	mm	
FPC Length	Р	32.823	mm	
FPC Pad Length (Metal)	Q	0.6	mm	
FPC Pad to Glass Edge (No Metal)	R	0.2	mm	

Ver 1.0 July. 02. 2013 25 /30





Product Specification

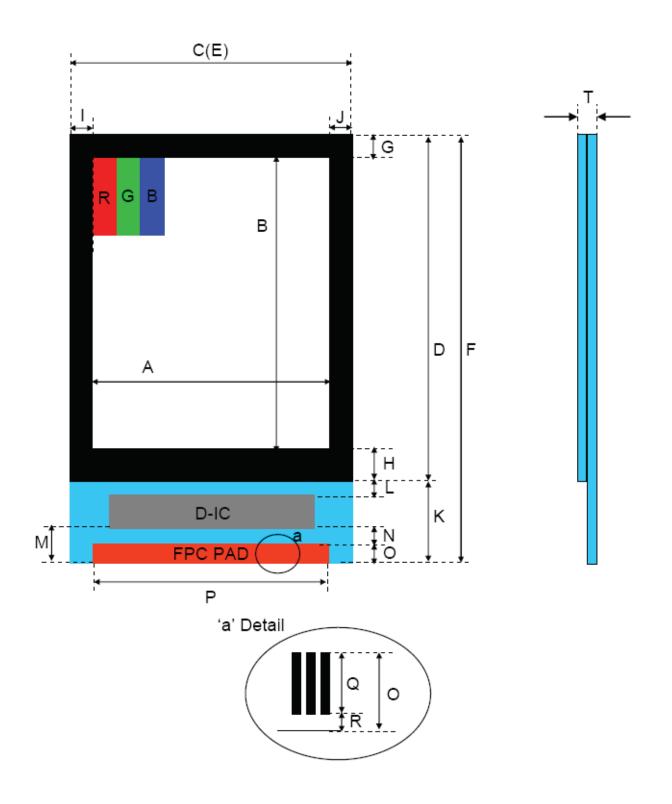


Fig 10.1. Symbol and reference of the outline dimension of LH500WF2-SH01 model

Ver 1.0 July. 02. 2013 26 /30





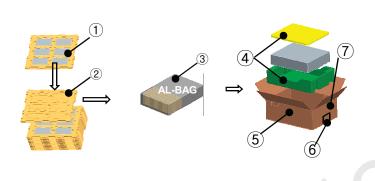
Product Specification

11. Packing Form

a) Package quantity in one box: 90 pcs

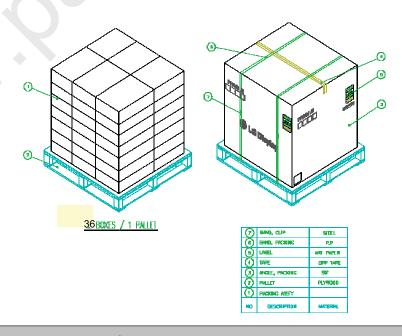
b) Box Size: 393mm X 339mm X 135mm

11.1. PACKING ASS'Y



NO.	Description	Material
1	Cell	
2	Packing Tray	PET
3	Bag	AL
4	Packing	EPS
5	Carton Box	SW
6	Tape	OPP 70MMx300m
7	Label	YUPO Paper 100x70

11.2. PALLET ASS'Y







Product Specification

12. Reliability

12.1 Environmental Reliability Tests

Reliability test conditions (Polarizer characteristics null)

No.	Test Items	Test Condition	Remark
1	Low Temperature Storage	Ta = -30 ℃ 240hrs	
2	High Temperature Storage	Ta = 80 ℃ 240hrs	
3	Low Temperature Operation	Ta = -20 °C 240hrs *1)	()
4	High Temperature Operation	Ta = 70℃ 240hrs	Module (Without
5	High Temperature and High Humidity Operation	Ta = 60 ℃ / 90%RH 240hrs (But no condensation dew)	Contamination)
6	Thermal Shock (Non-operation)	-30 ~ 80 °C, 100cycle	
7	Image Sticking *2)	Mosaic 8x6 1hr Sticking → Half Gray Under Level 2 within 2sec	
8	Packing Shock	1coner, 3edge, 6face / 76cmDrop	Dookogo
9	Packing Vibration	Random 1.5Grms Z direction 1hr.	Package

Notes:

No.1~ No.7 : No guarantee for panel, only for module with the above test conditions.

No.8~ No.9: Refer to '11.1 Packing Ass'y' on page 26.

- * 1) But no condensation of dew
- * 2) Display for 1hr on Mosaic 8 x 6 Pattern and then change Half Gray Pattern. (Image Sticking Test are implemented after LCD has been 'ON' and stable for approximately 30 minutes in a *Standard circumstance at 25°C.) [Judgment]

Under *Level 2 within 2 sec in a Dark room with naked eye

- * Standard circumstance: IEC60068-1
- * Level 2: No image sticking with ND Filter 10%





Mosaic 8 X 6 Pattern

[Result Evaluation Criteria]

LCD Panel should be at room temperature for minimum 24 hours after the reliability test is over. There should be no particular change which might affect the practical display function and the display quality should be conducted under only normal LCD operating condition.

Ver 1.0 July. 02. 2013 28 /30





Product Specification



CAUTION & HANDLING PRECAUTIONS

Please pay attention to the following when you use this TFT-LCD panel.

1. MOUNTING PRECAUTIONS

- 1) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials.
- 2) Since a TFT-LCD Panel is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc.
- 3) Do not leave at the high temperature and high humidity in long time.
- 4) Do not leave the TFT-LCD panel from direct sunlight.
- 5) Do not contact with water to avoid Metal corrosion.
- 6) The TFT-LCD Panel shall be installed flat, without twisting or bending

2. OPERATING PRECAUTIONS

- 1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage : V=±200mV(Over and under shoot voltage)
- 2) Response time depends on the temperature.(In lower temperature, it becomes longer.)
- 3) Brightness depends on the temperature. (In lower temperature, it becomes lower.) And in lower temperature, response time(required time that brightness is stable after turned on) becomes longer.
- 4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- 5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- 6) The TFT-LCD shall be operated within the temperature limits specified. When you operate the TFT-LCD panel at below(beyond) the limit specified, It may cause damage or image degradation. This phenomenon may not recover.

3. ELECTROSTATIC DISCHARGE CONTROL

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

Ver 1.0 July. 02. 2013 29 /30





Product Specification

4. PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of color filter. It may not recover

5. STORAGE

When storing TFT-LCD panel as spares for a long time, the following precautions are necessary.

- 1) Store them in a dark place. Do not expose to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- The TFT-LCD glass surface should not come in contact with any other object.It is recommended that they be stored in the container in which they were shipped.
- 3) As TFT-LCD panels are packed in a vacuum with PE bag and Al bag in Nitrogen gas environment,

Customer is required to keep the product under a good condition(25 degree, 50%) to prevent any of unwanted damage from the moisture, and chemicals, etc.

And recommended to use it in a short-time period, after it's unpacked.

6. HANDLING PRECAUTIONS FOR TFT-LCD Glass

Be careful when TFT-LCD panel is broken.(TFT-LCD is made of glass)

7. PACKING

When you must re-package a LCD after it has been removed from the original packaging, it is recommended to re-pack using the original package box and package material. And the LCD should be input to Module line as soon as it's unpacked to prevent panel corrosion because this gate material is consisted of Al/Mo which is weak in moisture, and chemicals, etc.